#### 503850260 06/01/2016

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
JUN KOYAMA	04/19/2013
SHUNPEI YAMAZAKI	04/15/2013

### **RECEIVING PARTY DATA**

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.	
Street Address:	398, HASE	
City:	ATSUGI-SHI, KANAGAWA-KEN	
State/Country:	JAPAN	
Postal Code:	243-0036	

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15144953

### CORRESPONDENCE DATA

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using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (202) 783-5070 Email: APSI@fr.com Correspondent Name: JOHN F. HAYDEN

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ATTORNEY DOCKET NUMBER:	12732-1188002	
NAME OF SUBMITTER:	JANELLE A. JACKSON	
SIGNATURE:	/Janelle A. Jackson/	
DATE SIGNED:	06/01/2016	

**Total Attachments: 1** 

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**PATENT** REEL: 038760 FRAME: 0129 503850260

## **ASSIGNMENT**

For valuable consideration, We, <u>Jun KOYAMA of Sagamihara, Kanagawa, Japan and Shunpei YAMAZAKI of Setagaya, Tokyo, Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co., Ltd.</u>, a <u>Japanese</u> corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of an application for United States Patent signed by us this day, entitled SEMICONDUCTOR DEVICE AND ELECTRONIC DEVICE, filed May 6, 2013, and assigned U.S. Serial Number 13/887,595 we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and serial number of said application when known; this assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Signature
Name: Jun/KOYAMA

Date: 04/19/2013

Signature
Name: Shunper YAMAZAKY

Date: 14/15/23/3

RECORDED: 06/01/2016

PATENT REEL: 038760 FRAME: 0130